

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	CHUNG HOON LEE	06/23/2022
RECEIVING PARTY DATA		
Name:	SEOUL SEMICONDUCTOR CO., LTD.	
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City:	ANSAN-SI	
State/Country:	KOREA, REPUBLIC OF	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	18451993
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ATTORNEY DOCKET NUMBER:	114898-8030.US01	
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SIGNATURE:	/Michaiah Copp/	
DATE SIGNED:	08/18/2023	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 4		
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In re Patent Application of:
SEOUL SEMICONDUCTOR CO., LTD.

Application No.: Not Yet Assigned

Filed: Herewith

For: HEADLAMP DEVICE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

DECLARATION AND ASSIGNMENT BY INVENTOR
UNDER RULE 37 C.F.R. § 1.63

I hereby declare that:

I believe I am an original joint inventor of a claimed invention in a patent application entitled:

HEADLAMP DEVICE

which was filed on _____, as Application No. _____, which is a
U.S. National Phase Application of International Patent Application No. PCT/KR2020/018851,
filed December 22, 2020, which further claims priority to Korean Patent Application No. 10-
2019-0172841, filed December 23, 2019.

I authorize and request an attorney appointed by an applicant or assignee to hereafter insert
above the filing date and application number of each application when known.

I believe the following persons are original joint inventors of the above-identified patent
application(s):

Chung Hoon LEE; Ansan-si, Republic of Korea;

I made, authorized to make, or hereby make or authorize to make the above-identified
patent application at the U.S. Patent and Trademark Office or other patent offices.

I have reviewed and understand the contents of the above-identified patent application(s)
including the claims.

I am aware of the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR §1.56.

I hereby acknowledge that any willful false statement made in the above declaration is punishable under 18 USC §1001 by fine or imprisonment of not more than five (5) years, or both.

INVENTOR ASSIGNMENT TO SEOUL SEMICONDUCTOR CO., LTD.

As a named inventor, I hereby assign to SEOUL SEMICONDUCTOR CO., LTD., a corporation having a place of business at 97-11, Sandan-ro 163beon-gil, Danwon-gu, Ansan-si, Gyeonggi-do, 15429, Republic of Korea, and its successors and assigns (collectively "the Assignee"), the entire right, title and interest throughout the world in any and all inventions and improvements which are described in the each and all of the following applications:

U.S. Patent Application No. _____, which was filed on _____, which is a U.S. National Phase Application of International Patent Application No. PCT/KR2020/018851, filed December 22, 2020, which further claims priority to Korean Patent Application No. 10-2019-0172841, filed December 23, 2019. I authorize and request an attorney appointed by an applicant or assignee to hereafter insert above the filing date and application number of each application when known.

This assignment includes the entire right, title and interest in the above-identified patent applications, all legal equivalents thereof in any country, any and all United States, Patent Cooperation Treaty, and other foreign patents, utility models, and design registrations granted for any of said inventions and improvements, including, but not limited to, all divisions, continuations, reissues, reexamination certificates, any and all certificates issued in any post-grant proceeding, and extensions of said applications and patents of the United States, Patent Cooperation Treaty, and all other foreign patents, utility models, and design registrations, and the right to claim priority based on the filing dates of the above-identified patent applications under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes, and the right to seek relief and recover all damages, including, but not limited to, a reasonable royalty, by reason of infringement or any other violation of patent or patent application rights. I authorize the Assignee to apply in all countries in the name of the Assignee for patents, utility models, design

registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements.

In addition, I hereby confirm the sale, assignment, and transfer to the Assignee of the entire right, title and interest throughout the world in said inventions and improvements by operation of an employment agreement between me and the Assignee existing at the time said inventions and improvements were made. Should I have any remaining interest, I hereby sell, assign, and transfer to the Assignee any right, title and interest I may have in said inventions and improvements anywhere in the world.

The foregoing assignments, sale and transfer have been made for good and valuable consideration, the receipt of which is hereby acknowledged by me.

I hereby represent and covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into that would conflict with the assignment of said inventions and improvements to the Assignee.

I further covenant for myself and my respective heirs, legal representatives and assigns, to assist the Assignee in handling various procedures, tasks and documentation in connection with this assignment, including, but not limited to, providing to the Assignee promptly upon the request of the Assignee all pertinent facts and documents relating to said invention and improvements, and said patents, said legal equivalents or other legal instrument as may be known and accessible to me and testifying as to the same in any interference, litigation, or proceeding relating thereto, and promptly executing and delivering to the Assignee or its legal representative any and all papers, documents, instruments or affidavits in connection with obtaining, maintaining, issuing or enforcing said application, said inventions and improvements, and said patents, said equivalents and other legal instrument which may be necessary or desirable to carry out the purposes thereof.

I am competent to execute the above declaration and assignment. I hereby have duly executed the declaration and assignment below with my name.

Full name of inventor: Chung Hoon LEE

Inventor's signature: _____

Date: 2022-06-23

The Assignee hereby acknowledges the assignment. The undersigned is authorized to act on behalf of the Assignee.

Assignee: SEOUL SEMICONDUCTOR CO., LTD.

Authorized officer's legal name: WooHyung Yi

Authorized officer's title: Director

Authorized officer's signature: [Signature]

Date: 2022.6.23

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